Microchip	Filter specification	TFS 2265	1/5
е	· ······ opeoiliealiei		

Measurement condition

Ambient temperature T_A : 23 °C Input power level: 0 dBm

Terminating impedance:

Source: 50 Ω Load: 50 Ω

Characteristics

Remark:

The reference level for the relative attenuation a_{rel} of the TFS2265 is the minimum attenuation in the passband. The maximum attenuation in the passband is defined as the insertion loss a_e . The nominal frequency f_N is fixed at 2265 MHz without any tolerance or limit. The values of relative attenuation a_{rel} are guaranteed over the whole operating temperature range. The frequency shift of the filter within the operating temperature range is included in the production tolerance scheme.

Data		typ.	value	tolerance / limit		İ	
Insertion loss in PB	a _e	4.4	dB	max.		5.0	dB
Nominal frequency	f_N	=				2265.0	MHz
Passband	РВ	=			f _N ±	90.0	MHz
Passband variation		1.3	dB	max.		2.0	dB
Passband variation in any 20 MHz segmen	t within PB	0.6	dB	max. 1.0 dB		dB	
Relative attenuation	a _{rel}						
500 MHz 1850 MHz		21	dB	min.		20	dB
2800 MHz 4000 MHz		30	dB	min.		25	dB
Input power level		-		max.		15	dBm
Operating temperature range	OTR	=		- 40 °C + 85 °C			
Storage temperature range		-		- 40 °C + 85 °C			
Temperature coefficient of frequency	TC_f *)	-76	ppm/K				

	*)	Δf	=	$TC_f(T$	_	$T_A)f_N$
--	----	------------	---	----------	---	-----------

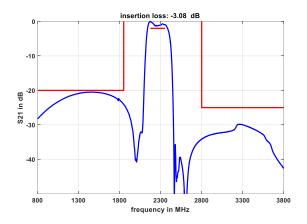
Generated:		

Checked / Approved:

Microchip Filter specification TFS 2265 2/5

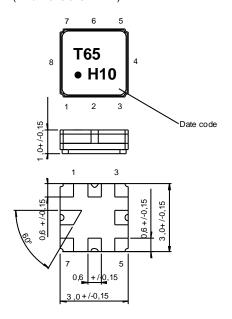
Filter characteristic





Construction and pin connection

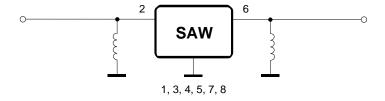
(All dimensions in mm)



1	Ground
2	Input
3	Ground
4	Ground
5	Ground
6	Output
7	Ground
8	Ground

Date code: Year + week H 2016 J 2017 K 2018

50 Ohm Test circuit



Microchip Filter specification TFS 2265 3/5

Stability characteristics, reliability

After the following tests the filter shall meet the whole specification:

1. Shock: 500 g, 1 ms, half sine wave, 3 shocks each plane;

DIN IEC 68 T2 - 27

2. Vibration: 10 Hz to 2000 Hz, 0.35 mm or 5 g respectively, 1 octave per min, 10 cycles per

plane, 3 planes; DIN IEC 68 T2 - 6

3. Change of

temperature: -55 °C to 125 °C / 15 min. each / 100 cycles

DIN IEC 68 part 2 - 14 Test N

4. Resistance to

solder heat (reflow): reflow possible: three times max.;

for temperature conditions, see page 4: "Air reflow temperature conditions"

5. ESD SAW devices are electrostatic discharge (ESD) sensitive devices

This filter is RoHS compliant (2011/65/EU)

Packing

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;

tape type II, embossed carrier tape with top cover tape on the upper side;

max. pieces of filters per reel:

reel of empty components at start:

reel of empty components at start including leader:

min. 300 mm

trailer:

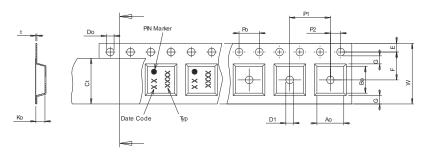
min. 500 mm

min. 300 mm

Pull Off Direction

Tape (all dimensions in mm)

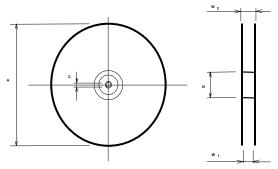
 8.00 ± 0.3 Ро 4.00 ± 0.1 Do 1.50 +0.1/-0 E F 1.75 ± 0.1 3.50 ± 0.05 G(min) 0.75 P2 2.00 ± 0.05 4.00 ± 0.1 D1(min) 1.50 Αo 3.25 ± 0.1 Во 3.25 ± 0.1 Ct 5.3 ± 0.1



Reel (all dimensions in mm)

A :330 or 180 W1 : 8.4 +1.5/-0 W2(max) : 14.4

W2(max) : 14.4 N(min) : 60 C : 13.0 ± 0.2



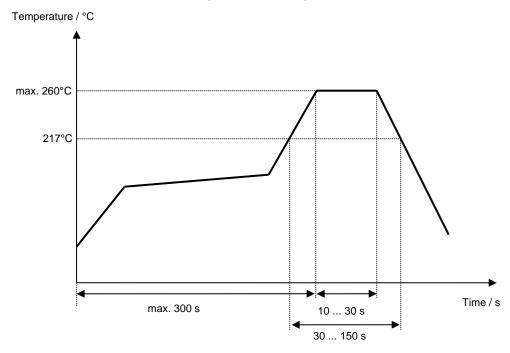
The minimum bending radius is 45 mm.

Microchip Filter specification TFS 2265 4/5

Air reflow temperature conditions

Conditions	Exposure
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile



Microchip Filter specification TFS 2265 5/5

History

Version	Reason of Changes	Name	Date
1.0	- Generation of development specification	A. Molke	02.10.2015
1.1	- Update of maximum input power level	A. Molke	12.10.2015
2.0	- Passband variation relaxed	A. Molke	01.03.2016
3.0	 Passband variation relaxed Passband variation in 20 MHz segments included Change from development spec to filter spec Typical values added Filter characteristic added Update of test circuit 	A. Molke	09.03.2016